

DESCRIPTION

The SPN1308W is the N-Channel enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where high-side switching, low in-line power loss, and resistance to transients are needed.

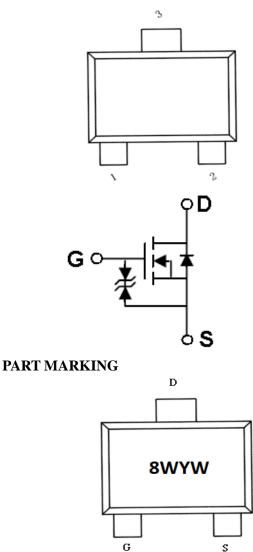
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

FEATURES

- N-Channel
 30V/1.4A,RDS(ON)=190mΩ@VGS=10V
 30V/1.0A,RDS(ON)=200mΩ@VGS=4.5V
 30V/0.5A,RDS(ON)=250mΩ@VGS=2.5V
- Super high density cell design for extremely low RDS(ON)
- Exceptional on-resistance and maximum DC current capability
- ESD protected
- SOT-323 package design

PIN CONFIGURATION(SOT-323)



Y:Year W:Week



PIN DESCRIPTION		
Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking		
SPN1308WS32RGB	SOT-323	8W		

* SPN1308WS32RGB : Tape Reel ; Pb – Free ; Halogen – Free ; 3K/Reel

ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter		Symbol	Typical	Unit
Drain-Source Voltage		VDSS	30	V
Gate –Source Voltage		VGSS	±12	V
Continuous Drain Current(TJ=150°C)	TA=25°C	Id	1.4	А
Pulsed Drain Current		Idm	6	А
Continuous Source Current(Diode Conduction)		Is	0.3	Α
Power Dissipation	TA=25°C	Pd	0.33	W
Operating Junction Temperature		TJ	-55/150	°C
Storage Temperature Range		Tstg	-55/150	°C
Thermal Resistance-Junction to Ambient		Reja	100	°C/W

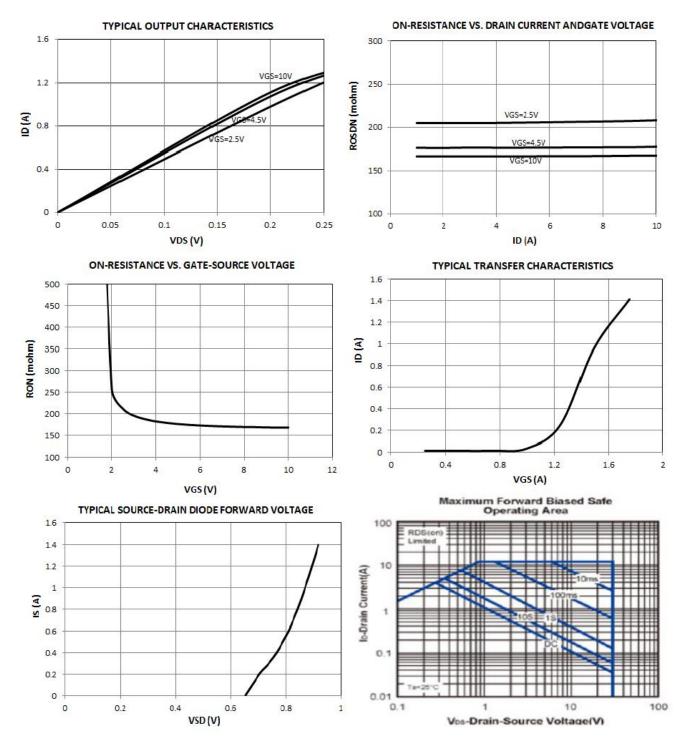


ELECTRICAL CHARACTERISTICS

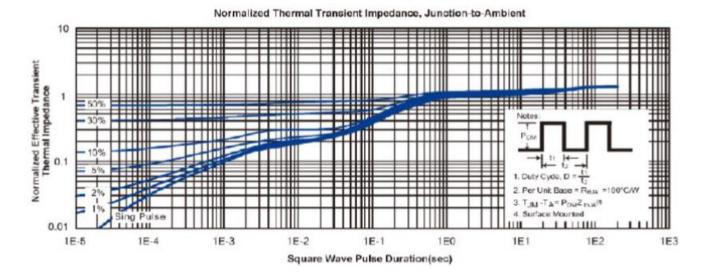
(TA=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V,ID= 250uA	30			v	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	0.4		1.0		
Gate Leakage Current	Igss	VDS=0V,VGS=±10V			±10	uA	
Zero Gate Voltage Drain Current		VDS=24V,VGS=0V			1		
	Idss	Vds=24V,Vgs=0V TJ=55℃			10	uA	
Drain-Source On-Resistance		VGS=10V,ID=1.4A			190		
	RDS(on)	VGS=4.5V,ID=1A			200	mΩ	
		Vgs=2.5V,Id=0.5A			250		
Diode Forward Voltage	Vsd	Is=1.4A,Vgs=0V			1.2	V	
Dynamic							
Total Gate Charge	Qg	VDS=15V,VGS=4.5V,		1.4		nC	
Gate-Source Charge	Qgs	ID=1.4A		0.3			
Gate-Drain Charge	Qgd			0.5			
Input Capacitance	Ciss			124		pF	
Output Capacitance	Coss	VDS=15VGS=0V f=1MHz		21			
Reverse Transfer Capacitance	Crss			10			
Turn-On Time	td(on)	V 15VD- 440		2.1		nS	
	tr	$V_{DD}=15V,RL=4.4\Omega$, ID=1.4A		9.0			
Turn-Off Time	td(off)	$V_{\text{GEN}}=10V, R_{\text{G}}=6\Omega$		8.5			
	tf			8.3		1	

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





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